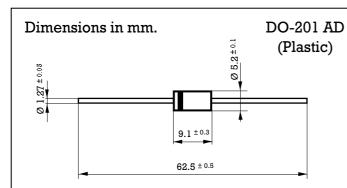
Current

3.0 A. at 55 °C.



# 3 Amp. Glass Passivated Fast Recovery Rectifier



HYPERECTIFIER

## Mounting instructions

- 1. Min. distance from body to soldering point, 4 mm.
- 2. Max. solder temperature, 350 °C.
- 3. Max. soldering time, 3.5 sec.
- 4. Do not bend lead at a point closer than 3 mm. to the body.

### • Glass passivated junction

• High current capability

Voltage

50 to 1000 V.

- The plastic material carries U/L recognition 94 V-0
- Terminals: Axial Leads
- Polarity: Color band denotes cathode

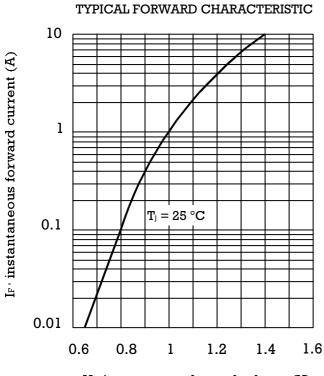
## Maximum Ratings, according to IEC publication No. 134

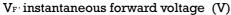
		RGP 30A	RGP 30B	RGP 30D	RGP 30G	RGP 30J	RGP 30K	RGP 30M	RGP 30MT
$V_{RRM}$	Peak recurrent reverse voltage (V)	50	100	200	400	600	800	1000	1000
$I_{F(AV)}$	Forward current at Tamb = 55 °C	3 A							
$I_{FRM}$	Recurrent peak forward current	30 A							
$I_{FSM}$	8.3 ms. peak forward surge current (Jedec Method)	125 A							
t <sub>rr</sub>	$\begin{array}{ll} \text{Max. reverse recovery} &  I_{\text{F}} = 0.5 \text{ A} \\ \text{I}_{\text{R}} = 1 \text{ A} \\ \text{I}_{\text{RR}} = 0.25 \text{ A} \end{array}$	150 ns 250 ns 500 ns 3			300 ns				
$T_{\rm j}$	Operating temperature range	− 65 to + 175 °C							
$T_{ m stg}$	Storage temperature range	− 65 to + 175 °C							
E <sub>rsm</sub>	Maximum non repetitive peak reverse avalanche energy. $I_R = 1A$ ; $T_J = 25$ °C	20 mJ							

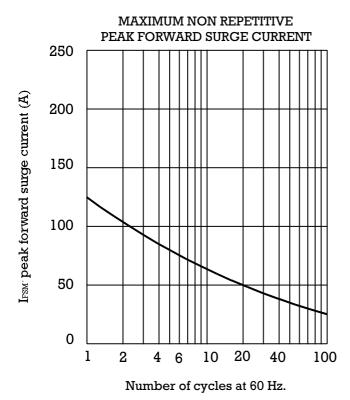
#### Electrical Characteristics at Tamb = 25 °C

$V_{\scriptscriptstyle F}$	Max. forward voltage drop at $I_F = 3 \text{ A}$	1.3 V
$I_R$	Max. reverse current at $V_{\text{RRM}}$ at 25 °C at 125 °C	5 μ A 100 μ A
R <sub>thj-a</sub>	Thermal resistance ( $I = 10 \text{ mm.}$ ) Max Typ	

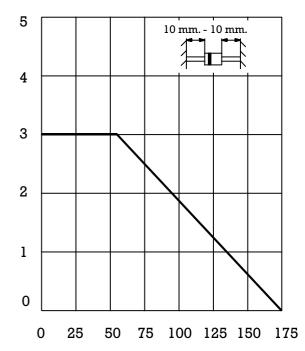
## Rating And Characteristic Curves







#### FORWARD CURRENT DERATING CURVE



IF(AV) average forward rectified current (A)

Tamb, ambient temperature (°C)

